



iNEMI

International Electronics Manufacturing Initiative

Concluding Remarks

Bob Pfahl
iNEMI
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Advancing manufacturing technology

Bifurcation of Pb-Free Activities

- **Consumer Products**
 - Optimize Processes and Materials
 - Reduce Cost
 - Increase Yield and Throughput
- **High-Reliability Products**
 - Taking the Pb exemption has changed the risk profile for High Reliability producers.
 - The components supply chain has rapidly converted to RoHS compliant offerings (Pb-free) with little motivation to continue to produce SnPb product.
 - Activities are underway to provide the industry with better understanding of Pb-free risks in high-reliability applications
 - Initiatives are being developed to understand and resolve risks

Upcoming Meetings

- **iNEMI Pb-free Component and Board Finish Reliability Project**
 - Location: APEX 2007, Room 519 Convention Center
 - Time: 3:30p.m. – 5:30 p.m.
- **IPC-iNEMI Reliability Summit**
 - Friday February 23, 2007. 8:30-4:30
 - Location: APEX 2007, Room 404AB, Convention Center



www.inemi.org

Email contacts:

Jim McElroy

jmcelroy@inemi.org

Bob Pfahl

bob.pfahl@inemi.org



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